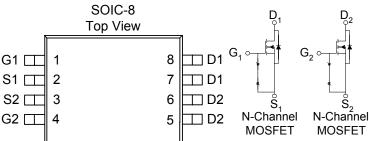
N-Channel 60-V (D-S) MOSFET

These miniature surface mount MOSFETs utilize a high cell density trench process to provide low $r_{DS(on)}$ and to ensure minimal power loss and heat dissipation. Typical applications are DC-DC converters and power management in portable and battery-powered products such as computers, printers, PCMCIA cards, cellular and cordless telephones.

•	Low $r_{DS(on)}$ provides higher efficiency and
	extends battery life

- Low thermal impedance copper leadframe SOIC-8 saves board space
- Fast switching speed
- High performance trench technology

PRODUCT SUMMARY				
V _{DS} (V)	$r_{DS(on)} m(\Omega)$	$I_{D}(A)$		
60	$35 @ V_{GS} = 10V$	±6.4		
00	$45 @ V_{GS} = 4.5V$	±5.6		





ABSOLUTE MAXIMUM RATINGS (T _A = 25 °C UNLESS OTHERWISE NOTED)					
Parameter		Symbol	Limit	Units	
Drain-Source Voltage			60	V	
Gate-Source Voltage			±20	V	
Continuous Drain Current ^a	$T_A=25^{\circ}C$ $T_A=70^{\circ}C$	Τ_	±6.4		
Continuous Drain Current	$T_A=70^{\circ}C$	1D	±5.2	A	
Pulsed Drain Current ^b			±40		
Continuous Source Current (Diode Conduction) ^a		I_S	2	A	
D Discipation 4i ma	$T_{A}=25^{\circ}C$ $T_{A}=70^{\circ}C$	D	2.1	W	
Power Dissipation ^a	$T_A=70^{\circ}C$	1 D	1.3		
Operating Junction and Storage Temperature Range	· ·	T _J , T _{stg}	-55 to 150	°C	

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Maximum	Units	
M · I · · · · · · · · · · · a	t <= 10 sec	$R_{ heta JA}$	62.5	°C/W	
Maximum Junction-to-Ambient ^a	Steady State		110	°C/W	

1

Notes

- a. Surface Mounted on 1" x 1" FR4 Board.
- b. Pulse width limited by maximum junction temperature

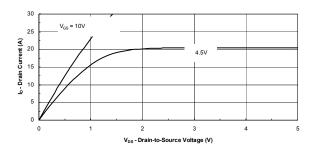
Davianastan	G	Trans Constitution	Limits			T 1 24	
Parameter	Symbol Test Conditions		Min	Тур	Max	Unit	
Static			•				
Gate-Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \text{ uA}$	1				
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = 20 \text{ V}$			±100	nA	
Zara Cata Valtaga Prain Current	Idss	$V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}$			1],,A	
Zero Gate Voltage Drain Current	IDSS	$V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55^{\circ}\text{C}$			10	uA	
On-State Drain Current ^A	I _{D(on)}	$V_{DS} = 5 \text{ V}, V_{GS} = 10 \text{ V}$	20			Α	
D : G O D : A	r _{DS(on)}	$V_{GS} = 10 \text{ V}, I_D = 6.4 \text{ A}$			35	mΩ	
Drain-Source On-Resistance ^A		$V_{GS} = 4.5 \text{ V}, I_D = 5.6 \text{ A}$			45		
Forward Tranconductance ^A	\mathbf{g}_{fs}	$V_{DS} = 15 \text{ V}, I_D = 6.4 \text{ A}$		11		S	
Diode Forward Voltage	V_{SD}	$I_S = 2.0 \text{ A}, V_{GS} = 0 \text{ V}$			1.2	V	
Dynamic ^b	•				•	•	
Total Gate Charge	Qg	$V_{DS} = 30 \text{ V}, V_{GS} = 4.5 \text{ V},$		12.5			
Gate-Source Charge	Q_{gs}	$I_D = 6.4 \text{ A}$		2.4		nC	
Gate-Drain Charge	Q_{gd}	ID = 0.4 A		2.6		1	
Switching						•	
Turn-On Delay Time	td(on)			11			
Rise Time	$t_{\rm r}$	$V_{\rm DD}=30$ V, $R_{\rm L}=30~\Omega$, Id = 1 A,		8		nS	
Turn-Off Delay Time	td(off)	$V_{GEN} = 10 \text{ V}$		19		113	
Fall-Time	t_{f}			6			

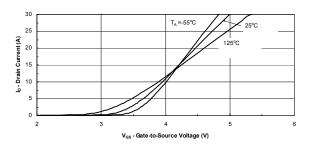
Notes

- a. Pulse test: $PW \le 300us duty cycle \le 2\%$.
- b. Guaranteed by design, not subject to production testing.

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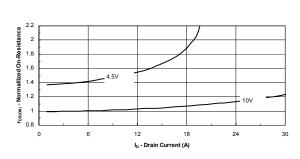
Typical Electrical Characteristics

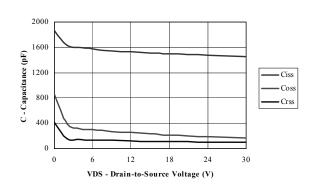




Output Characteristics

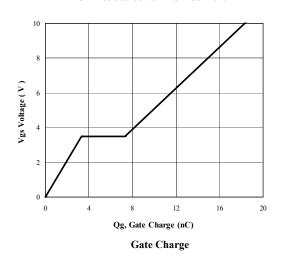
Transfer Characteristics

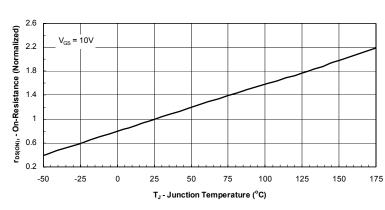




On-Resistance vs. Drain Current

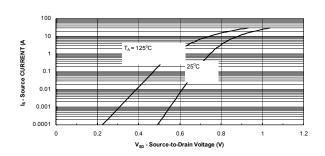
Capacitance

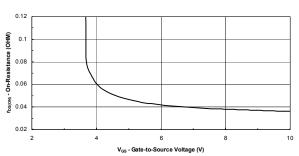




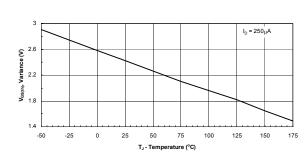
On-Resistance vs. Junction Temperature

Typical Electrical Characteristics (N-Channel)

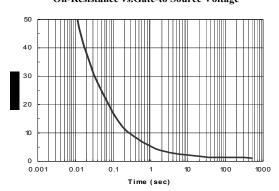




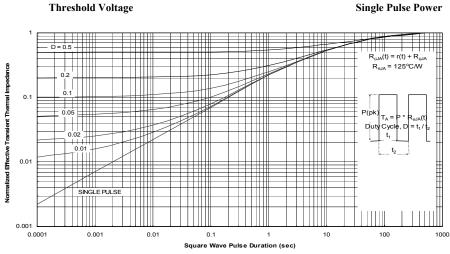
Source-Drain Diode Forward Voltage



On-Resistance vs.Gate-to Source Voltage



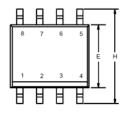
Threshold Voltage

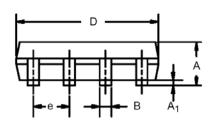


Normalized Thermal Transient Impedance, Junction-to-Ambient

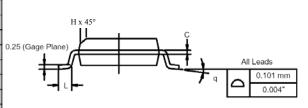
Package Information

SO-8: 8LEAD





	MILLIN	IETERS	INC	HES
Dim	Min	Max	Min	Max
Α	1.35	1.75	0.053	0.069
A ₁	0.10	0.20	0.004	0.008
В	0.35	0.51	0.014	0.020
С	0.19	0.25	0.0075	0.010
D	4.80	5.00	0.189	0.196
E	3.80	4.00	0.150	0.157
е	1.27	BSC	0.050	BSC
Н	5.80	6.20	0.228	0.244
h	0.25	0.50	0.010	0.020
L	0.50	0.93	0.020	0.037
q	0°	8°	0°	8°



PRELIMINARY